

L Number	Hits	Search Text	DB	Time stamp
1	811	deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 15:48
2	282088	(treat\$4 pretreat\$4 expos\$3 preparation preparatory prepar\$3) near10 (halogen halide chlor?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "ClF.sub.3" "WF.sub.6")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 13:25
3	89	(deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((treat\$4 pretreat\$4 expos\$3 preparation preparatory prepar\$3) near10 (halogen halide chlor?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "ClF.sub.3" "WF.sub.6")))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 14:11
4	16	((deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((treat\$4 pretreat\$4 expos\$3 preparation preparatory prepar\$3) near10 (halogen halide chlor?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "ClF.sub.3" "WF.sub.6")))) and @ad<19990726	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 14:15
5	26	((deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((treat\$4 pretreat\$4 expos\$3 preparation preparatory prepar\$3) near10 (halogen halide chlor?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "ClF.sub.3" "WF.sub.6")))) and @rlad<19990726	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 14:12
6	37	((deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((treat\$4 pretreat\$4 expos\$3 preparation preparatory prepar\$3) near10 (halogen halide chlor?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "ClF.sub.3" "WF.sub.6")))) and @ad<19990726) (((deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((treat\$4 pretreat\$4 expos\$3 preparation preparatory prepar\$3) near10 (halogen halide chlor?e fluori?e bromi?e iodi?e "F.sub.2" "Cl.sub.2" "Br.sub.2" "I.sub.2" "ClF.sub.3" "WF.sub.6")))) and @rlad<19990726)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 14:14
7	57	(deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((nucleat\$3 seed\$3) near12 (W tungsten)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 14:15
8	21	((deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((nucleat\$3 seed\$3) near12 (W tungsten))) and @ad<19990726	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 14:15
9	7	((deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((nucleat\$3 seed\$3) near12 (W tungsten))) and @rlad<19990726	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 14:15
10	25	((deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((nucleat\$3 seed\$3) near12 (W tungsten))) and @ad<19990726) (((deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((nucleat\$3 seed\$3) near12 (W tungsten))) and @rlad<19990726)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 14:35

11	3	(surface adj morphology) near15 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 14:37
12	14	(surface adj morphology) same (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 15:59
13	4	(deposit\$3 near3 ((two three plural dual multi) adj step)) near12 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 15:52
14	259	("WF.sub.6" near4 (Ar argon))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 15:52
15	146	("WF.sub.6" near4 (ammonia "NH.sub.3"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 15:53
16	17	(("WF.sub.6" near4 (Ar argon))) and (("WF.sub.6" near4 (ammonia "NH.sub.3")))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 15:53
17	8	(surface adj (texture rough\$4)) same (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 15:59
18	461	(retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 ((ammonia "NH.sub.3") near4 (deposit\$3 adsorp\$4 adher\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 16:03
19	6	(deposit\$3 near5 (WN WN?sub.? (tungsten adj nitride) "W.sub.2N" or "W.sub.2 N" or ("W.sub.2" adj N))) and ((retard\$3 retardation restrict\$3 reduc\$3 reduction prevent\$3 limit\$3) near6 ((ammonia "NH.sub.3") near4 (deposit\$3 adsorp\$4 adher\$3)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/15 16:03